

STPS1L40-Y

Automotive low drop power Schottky rectifier

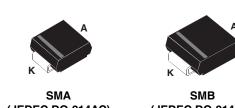
Features

- Very small conduction losses
- Negligible switching losses
- Low forward voltage drop
- Surface mount miniature packages
- Avalanche capability specified
- AEC-Q101 qualified
- ECOPACK[®]2 compliant components

Description

Single chip Schottky rectifiers suited to switched mode power supplies and high frequency DC to DC converters.

Packaged in SMA and SMB this device is especially intended for surface mounting and used in low voltage, high frequency inverters, free wheeling and polarity protection in automotive applications.



(JEDEC DO-214AC) STPS1L40AY



(JEDEC DO-214AA) STPS1L40UY

Table 1. **Device summary**

Symbol	Value
I _{F(AV)}	1 A
V _{RRM}	40 V
T _j (max)	150 °C
V _F (max)	0.42 V

1 Characteristics

Symbol	Paramete	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage		40	V
I _{F(RMS)}	Forward rms current		8	А
I _{F(AV)}	Average forward current	$T_L = 130 \ ^\circ C \delta = 0.5$	1	А
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal	60	А
I _{RRM}	Repetitive peak reverse current	ak reverse current $t_p = 2 \ \mu s \ F = 1 \ kHz \ square$		А
I _{RSM}	Non repetitive peak reverse current	e peak reverse current t _p = 100 µs square		Α
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \ \mu s \ T_j = 25 \ ^{\circ}C$		900	W
T _{stg}	Storage temperature range	- 65 to + 150	°C	
Тj	Operating junction temperature range	-40 to + 150	°C	
dV/dt	Critical rate of rise of reverse voltage	10000	V/µs	

1. $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3.Thermal resistance

Symbol	Parameter	Value	Unit	
P Junction to load	Junction to lead	SMA	30	°C/W
R _{th(j-l)}		SMB	25	0/14

Table 4. Static electrical characteristics

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
ı (1)	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}	-	-	35	μΑ
'R ` ´		T _j = 125 °C		-	6	10	mA
	V _F ⁽¹⁾ Forward voltage drop	T _j = 25 °C	I _F = 1 A	-	-	0.5	
v (1)		T _j = 125 °C		-	0.37	0.42	v
VF TO TOWARD VOILage		T _j = 25 °C		-	-	0.63	v
		T _j = 125 °C	I _F = 2 A	-	0.5	0.61	

1. Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$

To evaluate the conduction losses use the following equation: P = 0.23 x $I_{F(AV)}$ + 0.19 ${I_F}^2_{(RMS)}$



1.2

1.0

0.8

6.0

0.4

0.2

0.0

0

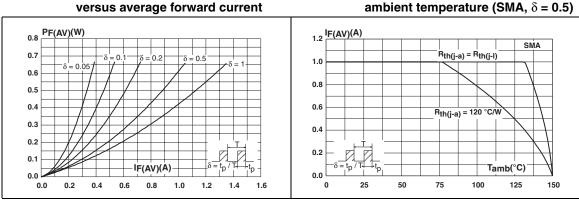
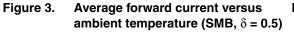
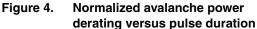


Figure 1. Average forward power dissipation Figure 2. Average forward current versus versus average forward current





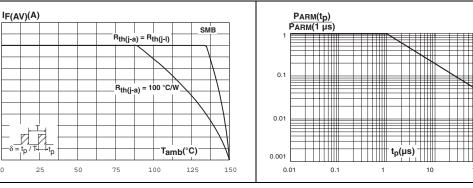
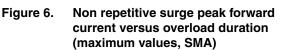


Figure 5. Normalized avalanche power derating versus junction temperature



100

1000

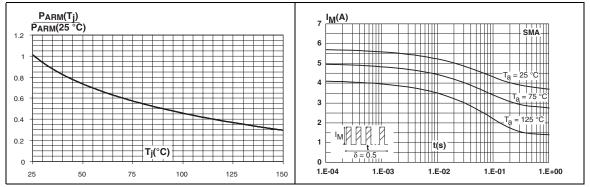
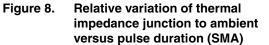




Figure 7. Non repetitive surge peak forward Figure 7. Current versus overload duration (maximum values, SMB)



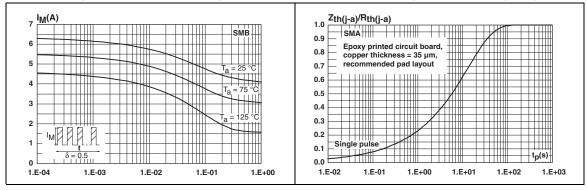
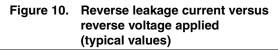
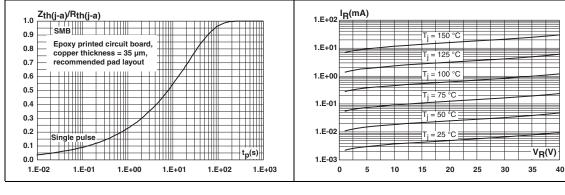
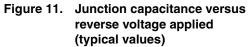
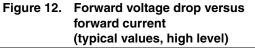


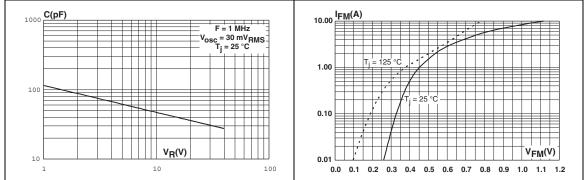
Figure 9. Relative variation of thermal impedance junction to ambient versus pulse duration (SMB)













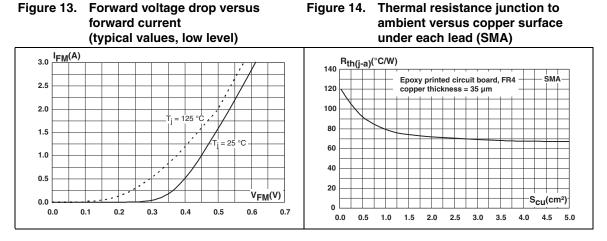
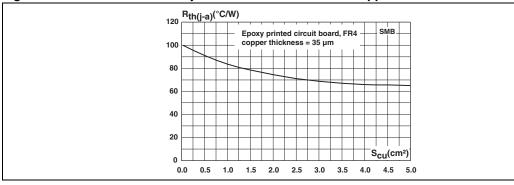


Figure 15. Thermal resistance junction to ambient versus copper surface under each lead (SMB)





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2 Package information

- Epoxy meets UL94, V0
- Cathode band (SMA, SMB)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 5. SMA dimensions

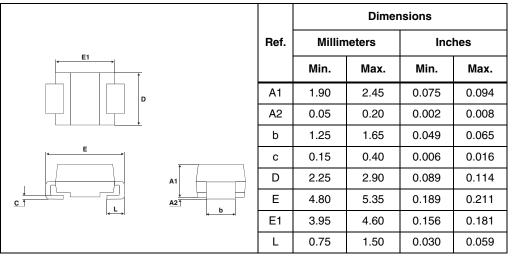


Figure 16. Footprint, dimensions in mm (inches)

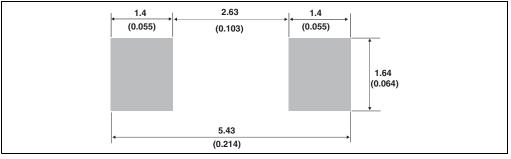
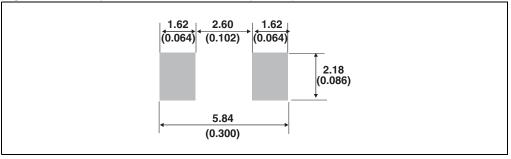




Table 0.	SIMB dimensio	115					
				Dimensions			
	E1		Ref.	Millimeters		Inches	
←				Min.	Max.	Min.	Max.
		A1	1.90	2.45	0.075	0.096	
		A2	0.05	0.20	0.002	0.008	
		b	1.95	2.20	0.077	0.087	
		С	0.15	0.40	0.006	0.016	
	A1	D	3.30	3.95	0.130	0.156	
		Е	5.10	5.60	0.201	0.220	
	l ∢ ▶	E1	4.05	4.60	0.159	0.181	
			L	0.75	1.50	0.030	0.059

Table 6.SMB dimensions

Figure 17. Footprint, dimensions in mm (inches)





3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS1L40AY	GB4Y	SMA	0.068 g	5000	Tape and reel
STPS1L40UY	GC4Y	SMB	0.107 g	2500	Tape and reel

4 Revision history

Table 8.Document revision history

Date	Revision	Changes
21-Oct-2011	1	First issue.



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